

Appl. No. : 10/618,957
Filed : July 14, 2003

AMENDMENT TO THE CLAIMS

Please amend the claims as follows.

1-7 (Canceled)

8 (Previously Presented): A transparent surface protective film for transparent conductive substrates protecting a surface opposite to a side of a conductive thin film of the transparent conductive substrates or a surface on a side of the conductive thin film, comprising:

a transparent base material film,

a transparent adhesive layer formed on one side of the base material film, and

a transparent antistatic layer formed on the other side of the base material film,

said transparent surface protective film being configured to maintain transparency even after one-hour heat treatment at 150°C,

wherein the antistatic layer comprises polymers having pyrrolidinium rings in main chains thereof.

9 (New): The transparent surface protective film of Claim 8, wherein the layer comprising polymers having pyrrolidinium rings in main chains thereof is not an adhesive layer.

10 (New): The transparent surface protective film of Claim 8, wherein the thickness of said adhesive layer is about 3-100 µm.

11 (New): The transparent surface protective film of Claim 8, wherein the thickness of said adhesive layer is about 5-40 µm.

12 (New): The transparent surface protective film of Claim 8, wherein said base material film comprises polyethylene terephthalates and/or polyethylene naphthalates.

13 (New): A transparent conductive substrate comprising a substrate and the surface protective film of Claim 8 attached on a surface of the substrate.